

Reliability and Test Condition

Item	Performance	Test Condition				
Electrical Performance	Electrical Performance Test					
Inductance	Refer to standard electrical	HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.				
DCR	characteristics list.	CH16502,Agilent33420A Micro-Ohm Mete				
Operating Temperature	-55°C~+155°C (Including self - temperature	uding self - temperature rise)				
Storage temperature and Humidity range	110~+40°C,50~60%RH (Product with taping) 255~+155°C (on board)					
Saturation Current (Isat1)	Approximately △L30%	Saturation DC Current (Isat) will cause L0 to drop △L(%)				
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise $\triangle T(^{\circ}C)$. 1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer				
Reliability Test						
High Temperature Exposure(Storage) AEC-Q200		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Temperature: 155±2°C Duration: 1000hrs Min. Measured at room temperature after placing for 24±2 hrs				
Temperature Cycling AEC-Q200	Appearance:No damage.	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Condition for 1 cycle Step1: -55±2°C 30min Min. Step2: 155±2°C transition time 1min MAX. Step3: 155±2°C 30min Min. Step4: Low temp. transition time 1min MAX. Number of cycles: 1000 Measured at room temperature after placing for 24±2 hrs				
Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value. Moisture Resistance	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles 1.Baked at 50°C for 25hrs, measured at room temperaturafter placing for 4 hrs. 2.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3.Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, keep at 25°C for 2hrs then keep at -10°C for 3hrs 4.Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.					
Biased Humidity (AEC-Q200)		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles) Humidity: 85±3% R.H, Temperature: 85°C±2°C Duration: 1000hrs Min with 100% rated current. Measured at room temperature after placing for 24±2 hrs				

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High Temperature Operational Life (AEC-Q200)	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value.	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Temperature: 155±2°C Duration: 1000hrs Min. with 100% rated current. Measured at room temperature after placing for 24±2 hrs						
External Visual	Appearance : No damage		Inspect device construction, marking and workmanship. Electrical Test not required.					
Physical Dimension	According to the product specification size measurement	Acc	According to the product specification size measurement					
Resistance to Solvents	Appearance:No damage.	Add	Add aqueous wash chemical - OKEM clean or equivalent.					
	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value.	Ту	pe	Peak value (g's)	Norm duration (I		Wave form	Velocity change (Vi)ft/sec
Mechanical Shock		l ——	ИD	100	6		Half-sine	12.3
	RDC: within ±15% of initial value and shall not exceed the specification value.	Lead 100 6 Half-sine 12.3 shocks in each direction along 3 perpendicular axes.						
Vibration		Osc Equ Tota	IPC/JEDEC J-STD-020D Classification Reflow Profiles Oscillation Frequency: 10~2K~10Hz for 20 minute Equipment: Vibration checker Total Amplitude:1.52mm±10% Testing Time: 12 hours (20 minutes, 12 cycles each of 3 orientations)			0 minute		
	1		Test condition:					
Resistance to Soldering Heat	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and	Т	-	oerature(℃)	Time(s)	ramp/	nperature /immersior nersion rat	I heat cycles I I
neat				260±5 Ider temp)	10±1	25mm	/s ±6 mm/	s 1
shall not exceed the specification value. Thermal shock (AEC-Q200)		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Condition for 1 cycle Step1: -55±2°C 15±1min Step2: 155±2°C within 20Sec. Step3: 155±2°C 15±1min Number of cycles: 300 Measured at room fempraturc after placing for 24±2 hrs						

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ESD	Appearance:No damage.	10% Time (ns)		
Solderability	More than 95% of the terminal electrode should be covered with solder •	a. Method B, 4 hrs @155°C dry heat @235°C±5°C b. Method B @ 215°C±5°C category 3.(8hours ± 15 min) c. Method D category 3. (8hours ± 15 min)@ 260°C±°C Preheat: 150°C,60sec. Solder: Sn96.5% Ag3% Cu0. 5% Temperature: 245±5°C ∘ Flux for lead free: Rosin. 9.5% ∘ Dip time: 4±1sec. Depth: completely cover the termination		
Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation		
Flammability	Electrical Test not required	V-0 or V-1 are acceptable.		
Board Flex	Appearance : No damage	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board. Support Solder Chip Printed circuit board before testing Probe to exert bending force Radius 340 Probe to exert bending force		



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Terminal Strength (SMD)	Appearance : No damage	Preconditioning: Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020D Classification Reflow Profiles) With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.

Note : When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition.

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Soldering and Mou	unting		
Soldering	Mildly activated rosin fluxes are preferred. JANTEK terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.		
Lead Free Solder re-flow:	Recommended temperature profiles for re-flow soldering in Figure 1.		
Soldering Iron (Figure 2):	Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. Note: • Preheat circuit and products to 150°C • Never contact the ceramic with the iron tip • Use a 20 watt soldering iron with tip diameter of 1.0mm • 355°C tip temperature (max) • 1.0mm tip diameter (max) • Limit soldering time to 4~5 sec		



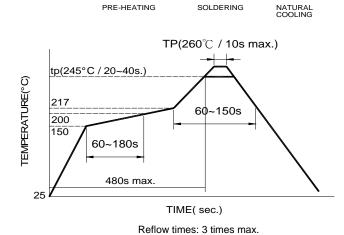


Fig.1

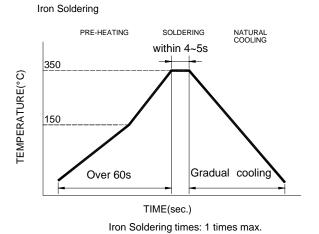


Fig.2

Friendly reminder

(1)) When there are questions concerning measurement result : measurement shall be made after 48 \pm 2 hours of
	recovery under the standard condition

- (2) This power choke coil itself does not have any protective function in abnormal condition such as overload, short-circuit and open-circuit conditions, etc. Therefore, it shall be confirmed as the end product that there is no risk of smoking, fire, dielectric withstand voltage, insulation resistance, etc. in abnormal conditions to provide protective devices and/or protection circuit in the end product.
- (3) When this power choke coil was used in a similar or new product to the original one, sometimes it might not be able to satisfy the specifications due to different condition of use.
- (4) Dielectric withstanding test with higher voltage than specific value will damage insulating material and shorten its life.
- (5) This power choke coil must not be used in wet condition by water, coffee or any liquid because insulation strength becomes very low in this condition.
- (6) Please consult our company to confirm the reliability of the process required to wash or use or exposure to a chemical solvent used in this product.